

## **Application Data Sheet**

### **Application Information**

<b>Application number::</b>	Unassigned
<b>Filing Date::</b>	12/03/2003
<b>Application Type::</b>	Regular
<b>Subject Matter::</b>	Utility
<b>Suggested classification::</b>	
<b>Suggested Group Art Unit::</b>	
<b>CD-ROM or CD-R?::</b>	None
<b>Computer Readable Form (CRF)?::</b>	No
<b>Title::</b>	Fabrication of sub-50 nm Solid-State Nanostructures Based on Nanolithography
<b>Attorney Docket Number::</b>	083847-0231
<b>Request for Early Publication?::</b>	No
<b>Request for Non-Publication?::</b>	No
<b>Suggested Drawing Figure::</b>	1
<b>Total Drawing Sheets::</b>	26
<b>Small Entity?::</b>	No
<b>Petition included?::</b>	No
<b>Licensed US Govt. Agency::</b>	Air Force Office of Scientific Research; DARPA; National Science Foundation
<b>Contract or Grant Numbers One::</b>	F49620-00-1-0283/PO1; DAAD 19-00-1- 0414; EEC-0118025
<b>Secrecy Order in Parent Appl.?::</b>	No

### **Applicant Information**

<b>Applicant Authority Type::</b>	Inventor
<b>Primary Citizenship Country::</b>	US
<b>Status::</b>	Full Capacity

**Given Name::** Hua  
**Family Name::** Zhang  
**City of Residence::** Chicago  
**Country of Residence ::**  
**Street of mailing address::**  
**City of mailing address::** Chicago  
**State or Province of mailing address::** IL

**Applicant Authority Type::** Inventor  
**Primary Citizenship Country::** US  
**Status::** Full Capacity  
**Given Name::** Chad A.  
**Family Name::** Mirkin  
**City of Residence::** Chicago  
**Country of Residence::**  
**Street of mailing address::**  
**City of mailing address::** Chicago  
**State or Province of mailing address::** IL

**Applicant Authority Type::** Inventor  
**Primary Citizenship Country::** US  
**Status::** Full Capacity  
**Given Name::** Dana  
**Family Name::** Weinberger  
**City of Residence::** Evanston  
**Country of Residence::**  
**Street of mailing address::**  
**City of mailing address::** Evanston  
**State or Province of mailing address::** IL

**Applicant Authority Type::** Inventor

**Primary Citizenship Country::** US  
**Status::** Full Capacity  
**Given Name::** Sunheun  
**Family Name::** Hong  
**City of Residence::** Evanston  
**Country of Residence::**  
**Street of mailing address::**  
**City of mailing address::** Evanston  
**State or Province of mailing address::** IL

**Correspondence Information**

**Correspondence Customer Number::** 22428  
**E-Mail address::** PTOMailWashington@Foley.com

**Representative Information**

<b>Representative Customer Number::</b>	22428	
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**Domestic Priority Information**

<b>Application::</b>	<b>Continuity Type::</b>	<b>Parent Application::</b>	<b>Parent Filing Date::</b>
This Application	An application claiming the benefit under 35 USC 119(e)	60/430,349	12/03/2002
This Application	Continuation-In-Part of	09/866,533	05/24/2001
09/866,533	An application claiming the benefit under 35 USC 119(e)	60/207,713	05/26/2000

#### **Foreign Priority Information**

<b>Country::</b>	<b>Application number::</b>	<b>Filing Date::</b>	<b>Priority Claimed::</b>

#### **Assignee Information**

**Assignee name::**